

**Course: Semiconductor Device Fundamentals**

**Level: Undergraduate**

**Module: B**

**Test: B13**

**Type: Closed Book, Closed Notes**

**Note: Available Info/Equation Sheets**

**Problem Weighting---** T2-1...16 (8 each diagram)

T2-2...16 (a-5, b-5, c-6)

T2-3...16

T2-4...16

T2-5...16 (a-5, b-6, c-5)

T2-6...20 (a-6, b-8, c-6)

NAME \_\_\_\_\_

T2 - 1

\_\_\_\_\_ SCORE

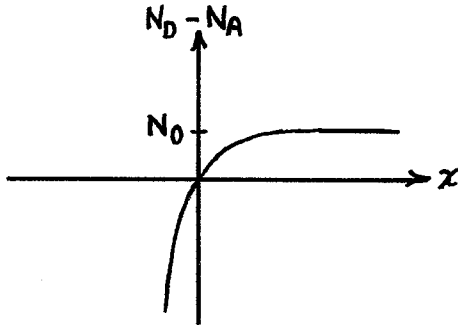
During the course of the PN junction discussion we encountered three phenomena which can give rise to large junction currents under certain conditions; namely, avalanching, the Zener process, and punch-through. Using the energy band diagram, describe **TWO** of the cited three phenomena. (If desired, you may add a few words to forestall a misinterpretation of your diagrams.)

NAME \_\_\_\_\_

T2 - 2

SCORE \_\_\_\_\_

The doping profile inside a PN junction diode is as shown below.

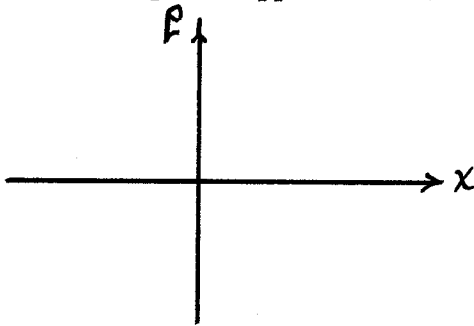


$$N_D - N_A = N_0 (1 - e^{-ax})$$

where  $N_0$  and  $a$  are constants

(a) Give a concise statement of the depletion approximation.

(b) Invoking the depletion approximation, make a sketch of the charge density inside the diode.



(c) Work out an expression for the electric field,  $\mathcal{E}(x)$ , inside the depletion region.

NAME \_\_\_\_\_

T2 - 3

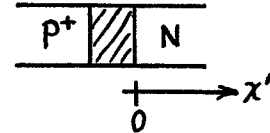
\_\_\_\_\_ SCORE

In the charge-control analysis of the PN junction transient response we showed that, for a P<sup>+</sup>-N diode,

$$\frac{dQ_P}{dt} = i - \frac{Q_P}{\tau_p}$$

where

$$Q_P \equiv qA \int_0^{\infty} \Delta p_n(x') dx'$$



Moreover, in the standard derivation of the Ideal Diode Equation, we concluded

$$\Delta p_n(x') = \frac{n_i^2}{N_D} (e^{qV_A/kT} - 1) e^{-x'/L_P}$$

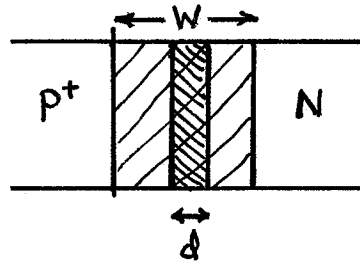
Using only the relationships cited in this problem, show that one can establish the Ideal Diode Equation valid for a P<sup>+</sup>-N junction diode.

NAME \_\_\_\_\_

T2 - 4

\_\_\_\_\_ SCORE

Inside a Si diode, maintained at room temperature, there is a region of width  $d$  which contains **three** times as many R-G centers as adjoining regions. This special region (as envisioned below) lies totally inside the depletion region when the diode is zero biased.



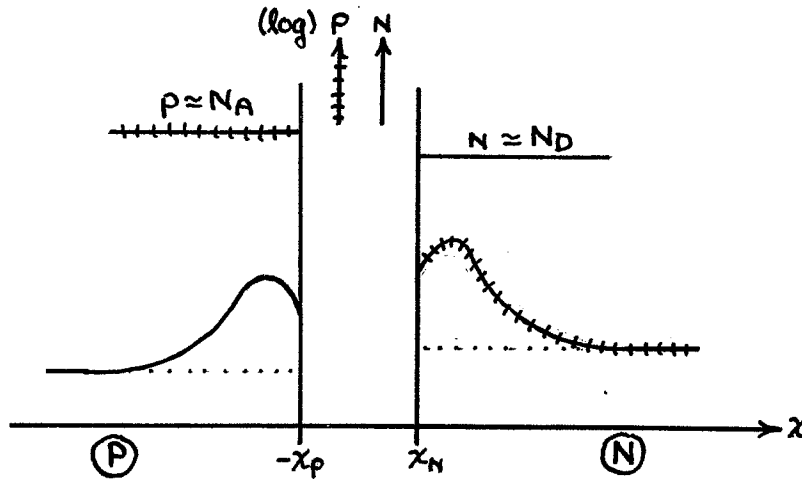
Derive an expression for the R-G current ( $I_{R-G}$ ) to be expected from the diode under reverse bias conditions. (Assume the applied reverse-bias voltage is greater than a few  $kT/q$  volts.) **RECORD ALL DERIVATIONAL STEPS.**

NAME \_\_\_\_\_

T2 - 5

SCORE \_\_\_\_\_

The carrier concentrations inside an ideal pn junction diode are as shown below.



(a) Is the junction forward or reverse biased; i.e., is the p-side potential positive or negative relative to the n-side potential? EXPLAIN how you arrived at your answer.

(b) What is the direction of current flow inside the diode? (To avoid confusion, specify if the current flows from  $P \rightarrow N$  or  $N \rightarrow P$ .) EXPLAIN how you arrived at your answer.

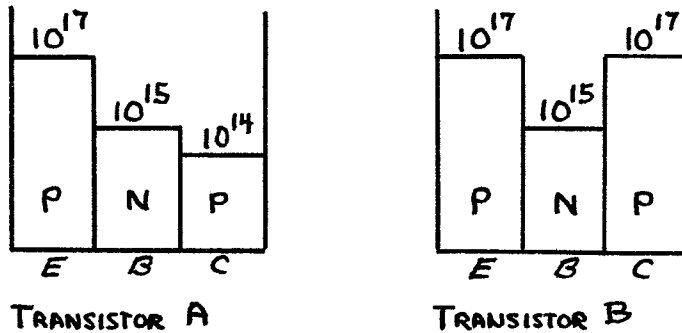
(c) Do low level injection conditions prevail inside the diode? EXPLAIN how you arrived at your answer.

NAME \_\_\_\_\_

T2 - 6

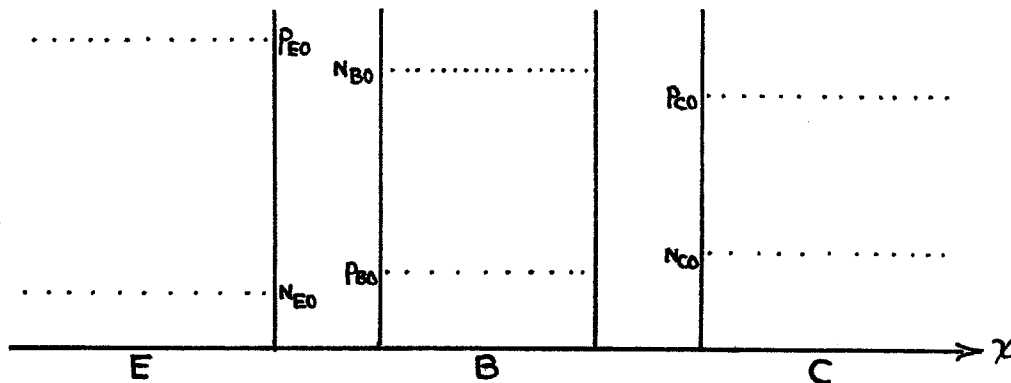
SCORE \_\_\_\_\_

Two ideal transistors (BJT's) are identical except for the dopings of their collector regions. The doping profiles of Transistors A and B are shown below.



(a) Which transistor will exhibit the larger sensitivity to base-width modulation under active mode operation? EXPLAIN.

(b) Sketch the **minority and majority** carrier distributions in the quasi-neutral regions of Transistor A under active mode biasing. Assume low level injection conditions prevail and  $W_B \ll L_B$ .



(c) Complete the following table by indicating the polarity (F = forward or R = reverse) of the bias being applied across the emitter-base and collector-base junctions of a BJT under the specified biasing mode.

Biasing Mode	Polarity of bias	
	emitter - base	collector - base
Active		
Cut - off		
Saturation		